

10/533288

JC17 Rec'd PCT/PTO 29 APR 2005  
PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

#3/A

In re application of:

Masahiko HIRATA et al

National phase of International Application No. PCT/JP2003/013996

International filing date: October 31, 2003

Date of entry into national phase: April 29, 2005

For: LEAD-FREE SOLDER AND SOLDERED ARTICLE

PRELIMINARY AMENDMENT

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

Prior to examination, please amend the referenced  
application as shown below: